

ITEM :

CRYSTAL RESONATOR

TYPE :

DSX211G

NOMINAL FREQUENCY :

26.000MHz

SPEC No. :

1ZZCAB26000LB0A

Please acknowledge receipt of this specification by signing and returning a copy to us.

	RECEIPT
DATE	
RECEIVED	(signature) (name)



1. ELECTRICAL CHARACTERISTICS

(This test shall be performed under the conditions of temp.at 25 \pm 3°C, Relative Humidity 60% max.)

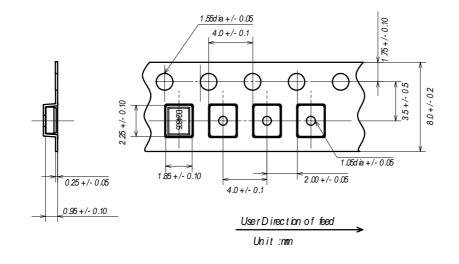
(1) NOMINAL FREQUENCY	26.000	000 MHz		
(2) OVERTONE ORDER	Fundan	nental		
(3) LOAD CAPACITANCE(CL)	19.0	pF		
(4) FREQUENCY TOLERANCE	±7 p	opm max. (at +25 ± 3 °C)		
(5) DRIVE LEVEL	10 :	± 2 μW		
(6) SERIES RESISTANCE	150 Ω	max. (at Series)		
(7) OPERATING TEMPERATURE RANGE	-40	~ +85 °C		
(8) FREQUENCY CHARACTERISTICS OVER TEMPERATURE	±15 µ	opm max. / -40 ~ +85 °C	(ref. to +25°C)	
(9) SHUNT CAPACITANCE	2pF ma	x.		
(10) INSULATION RESISTANCE	500MΩ	min. / DC 100 ± 15V		
(11) STORAGE TEMPERATURE RANGE	-40	~ +85 °C		
2. CONSTRUCTION (1) DIMENSIONS AND MARKING	Refer to	o 4.		
3. OTHER SPECIFICATIONS (1) EMBOSS CARRIER TAPE & REEL	Refer to	5		
(2) PACKING	Refer to			
(3) REFLOW CONDITIONS (REFERENCE)	Refer to			
(4) LAND PATTERN (REFERENCE)	Refer to			
(5) RELIABILITY SPECIFICATION	Refer to			
(6) OTHER		5		
HANDLING INSTRUCTIONS	Refer to	o 12.		
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4. DIMENSIONS AND MARKING

$\frac{2.0 + / \cdot 0.1}{(1 \cdot 1)^{1}(2 \cdot 1)(3 \cdot 1)}$ $\frac{125}{6}$ $= Top \forall iew > 100$
$ \begin{array}{c} & \downarrow \\ $
Figure-1 unit : mm Tolerance : ±0.1
Logo(1) and Nominal Frequency (2) should be printed as follows by producing district
Made in INDONESIA> Spec. No.: 1ZZCAB26000LB0A , Logo : D , Frequency: 26
* Made in INDONESIA : Under Bar with D
Nominal Frequency (2) = Mark two digits from upper decimal point (ex. 26.000000 MHz> 26)
Manufacturing lot No.(3) Year : The last digit of the year week : We gave the sequence of week numbers 01(first week) for production date. there are starting from 1st of Jan. However,add '0' figure to the first week during the nine weeks. The week means are from Sunday to Saturday.
(ex. 2011/10/13> 142)
TITLE REMARK DSX211G TYPE QUARTZ CRYSTAL SPECIFICATION

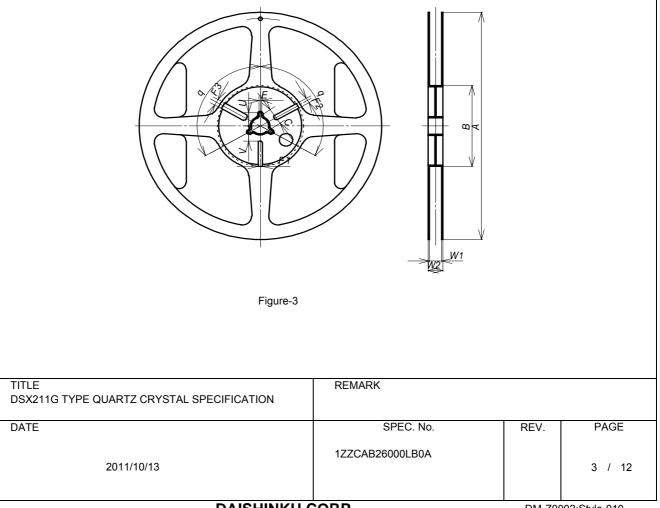
5. EMBOSS CARRIER TAPE & REEL

(1) Dimensions of embossed carrier tape





(2) Dimensions of tape reel



				(UNIT:mm)	
Proc	ducts			DSX211G	
Iten	า		Mark	Dimensions Angle	
	Dia	ameter	A	180 dia. +0.0 / -3.0	
Flange	Inside of Frange		W1	9.0 ± 0.3	
	Outside of Frange		W2	11.4 ± 1.0	
	Inside	Diameter	В	60 dia. +1.0 / -0.0	
			F1	3.0 ± 0.2	
Center Core	Center Core Slit	Width	F2	4.0 ± 0.2	
				F3	5.0 ± 0.2
		Length	V	11.9 +0.5 / -0.0	
		Angle	q	120°	
	Spindle Diameter		С	13 dia. ± 0.2	
		Width	E	2.0 ± 0.5	
	Key Seats	Length	U	10.5 ± 0.4	
		Angle	q	120°	

(3) Storage condition Temperature : +40 °C max.

Relative Humidity : 80% max.

(It is a guaranteed term because it obtains an excellent soldering: 6 months)

(4) Standard packing quantity

3,000 pcs/reel

(5) Material of the tape

Таре	Material
Carrier tape	Polystyrene+Carbon
Cover tape	Polyester

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(6) Label contents

Туре Our specification No. Your Part No. Lot No. Nominal Frequency Quantity Our Company Name Producting Country

Stick a label on the each reel.

(7) Taping dimension

·			
	Cover-tape	The length of cover-tape in the leader is more than 400mm	
Leader	O a main a f	including empty embossed area.	
	Carrier-tape	After all products were packaged, must remain more than twenty pieces	
	Cover-tape	or 400mm empty area, which should be sealed by cover-tape. The tip of cover-tape shall be fixed temporary by paper tape and roll arour	od .
Terminal	Cover-lape	the core of reel one round.	
	Carrier-tape	The empty embossed area which are sealed by cover-tape must remain	
		more than 40mm.	
		London	
	Terminal	Component Leader	
	<i>一</i> 一一一一一一一一一一一一一一一一一一一一一一一一一一一一一一一一一一一		
		$\leq \leq $	
	Empty Compone	nts Unreeling direction Empty Components	
	$\leftarrow \rightarrow$	Cover-tape	
		Figure-4	
It has to be Pulling di Speed		n/min.	
165 ~ 180 °		Pulling direction	
	X		
	Fi	ure-5	
Other standa	rds shall be base	l on JIS C 0806 -1990.	
		REMARK	
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6. PACKING

(1) STORAGE METHOD

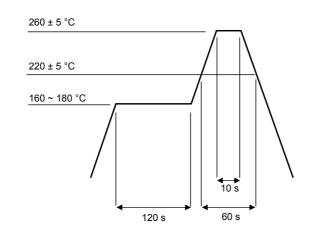
Figure-3	Label contents The type of product Lot No. Specification Quantity Shipment Day Remark		
(2) BOX SIZE			
From lot size packingsize shall be changed. In the upper and lower part and the opening in box it sha aircushion sheets.	all be protected products using		
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7. REFLOW CONDITIONS (REFERENCE)

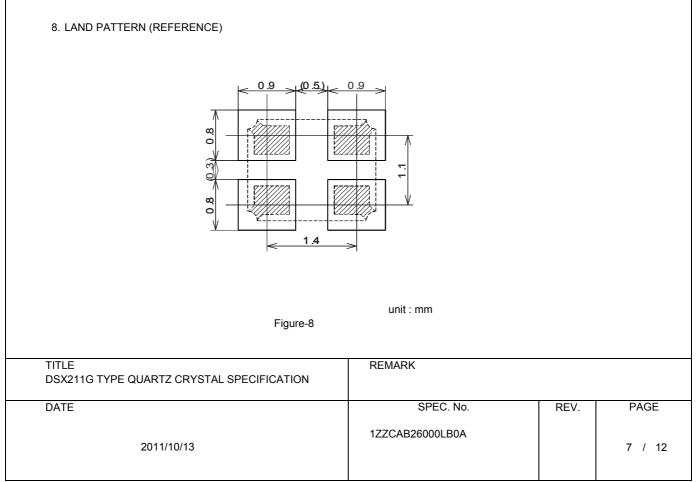
During the solder reflow process, please complete within following temperature, period. Reflow soldering shall be allowed only 3 times.



Total time : 200 s max.

Figure-7

HANDSOLDERING METHOD : 350 \pm 10 °C , 3+1/-0s Each terminal once (Please take care so that a soldering iron should not touch a product directly.)



9. MECHANICAL ENDURANCE			
 (1) SHOCK (ACCELERATION) After the following test,parts shall conform specification 11./ 1000m/s² by 6ms X,Y,Z each axis (6 directions), 3cycles 	Α.		
 (2) SHOCK (MOUNTING DROP) After the following test,parts shall conform specification 11./ 3cycles(18times) drop from 150 cm heights to concrete. Further,parts shall be solderd on substrate, fixed Aluminum Substrate materials : Glass Epoxy 1 cycle : each 1 times of 6 direction 	materials(about 100g).		
 (3) VIBRATION After the following test,parts shall conform specification 11.7 and no abnormal appearance shall be observed. Frequency of Vibration : 10 ~ 500 ~ 10 Hz Amplitude(p-p) : Sine waves of 1.5m Cycle : 11min Vibration axis : X.Y.Z Vibration period : 2 h for each axis 			
 (4) SEAL Less than 2.0×10⁻⁹ Pa m³/s. by Helium leak detector. Also, no serial bubble is observed by Fluorocarbon tests. 			
 (5) SOLDERABILITY After the following test, more than 95% of terminal shall be 3 ± 0.5 s dip in 245 ± 5 °C solder. (Solder composition : Sn-3Ag-0.5Cu) (Use rosin type flux for the second second			
 (6) RESISTANCE TO SOLDERING HEAT (REFLOW) 48 h past at room temperature from following test, parts shall perform the attached Reflow conditions to reference. 	Il conform specification 11.A.		
 (7) RESISTANCE TO SOLDERING HEAT (HAND SOLDERIN 48 h past at room temperature from following test, parts shai 350 ± 10°C, 3+1/-0s Each terminal once. 			
 (8) SUBSTRATE BENDING After the following test,parts shall conform specification 11./ and no abnormality shall be observed in external appearance tightnen and others shall be based on ET-7403 of EIAJ. Mount the specimen on substrate. Apply the following pressure Direction : see right figure Speed : about 1.0 mm/s Hours : 5±1s Amount of substrate : 3 mm max. 		P.C.B.	
		-2	
	REMARK		
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tightness and others shall be based on ET-7403 of EIA	
Mount the specimen on substrate. Apply the following pressure Weight : 5 N Hours : 10 ± 1 s Direction : see right figure	R0.5 specimen
(10) BODY STRENGTH After the following test,parts shall conform specification and no abnormality shall be observed in external appertightness and others shall be based on ET-7403 of EIA	earance and sealing
Mount the specimen on substrate. Apply the following pressure Weight : 5 N Hours : 10 ± 1 s Direction : see right figure	L L >= W L L
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10. ENVIRONMENTAL ENDURANCE

(1) LOW TEMPERATURE

2 h past at room temperature after following test, parts shall conform specification 11.A. 240 h , -40 \pm 3 °C.

(2) HUMIDITY

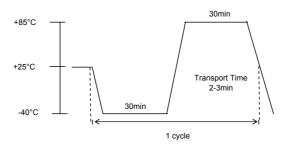
2 h past at room temperature after following test, parts shall conform specification 11.A. 240 h +85 \pm 2 °C , relative humidity 85 \pm 5%.

(3) HIGH TEMPERATURE

2 h past at room temperature after following test, parts shall conform specification 11.A. 240 h , $\$ +85 ± 2 °C.

(4) TEMPERATURE CYCLE

2 h past at room temperature after 25 cycles of followingtest, parts shall conform specification 11.A.



11. SPECIFICATION

Frequency Variation and Equivalent Resistance shall be within Table below after the reliability test.

Spec.	Frequency Variation	Equivalent Resistance
Α	±2ppm	± 15 % or 2.0 Ω max. (Use larger specification)
В	±5ppm	± 20 % or 3.0 Ω max. (Use larger specification)
С	±10ppm	± 20 % or 3.0 Ω max. (Use larger specification)
D	±20ppm	± 25 % or 10.0 Ω max. (Use larger specification)

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12. DSX211G TYPE QUARTZ CRYSTAL HANDLING INSTRUCTIONS

(1) SOLDERING

Please perform the attached Reflow conditions to reference within 3 times.

(2) MOUNT

Crystal products are designed to be compatible with automatic mounting. Be sure to have a mounting test in advance by using the actual mounting machine and check that the characteristics of the products are not damaged by the automatic mounting. In the process where the boad is warped, such as board separation process, be careful that the warping does not influence the characteristics and soldering of crystal products. Since mounting by Ultrasonic welding and processing have a possibility of an excessive vibration spreading inside a crystal resonator and becoming the cause of characteristic deterioration and not oscillating, it does not recommend.

(3) WASHING

About use of the washing liquid of a basin system, an alcoholic system, and a chlorofluorocarbon-replacing material system, it is checking that it is satisfactory. However please consult in advance about other washing liquid. Although the check about ultrasonic washing is performed, since it is an examination with a simple substance, the check for the second time by the use state is recommended.

(4) THE CAUTIONS ON USE

The piece of crystal it is processed very smaller than the conventional thing

- inside DSX211G series crystal unit may be damaged,
- if excessive excitation electric power is applied.

Please use it below with the value specified on a catalog and specifications.

Please refrain from forming patterns between crystal land pattern's since there is

a possibility to cause crack in base.

If the temperature is higher than 280 °C, there is a possibility for the sealing glass to remelt. Avoid using the product at temperature higher than specified.

(5) HANDLING OF A PRODUCT

DSX211G series has sufficient intensity to fall and vibration. However when too much shock is added according to a certain cause, the use after a characteristic check is recommended.

(6) STORAGE

Since the soldering nature of a terminal may be degraded, please avoid storage in high temperature and a humid place. Please keep it in the place which direct rays do not hit and dew condensation does not generate.

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Rev.No Date Reason Contents Approved Checked Drawn 2011/10/13 The first edition. T.Okishio -Y.Maeda M.Shikai -

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